2SK2423

Silicon N-Channel MOS FET

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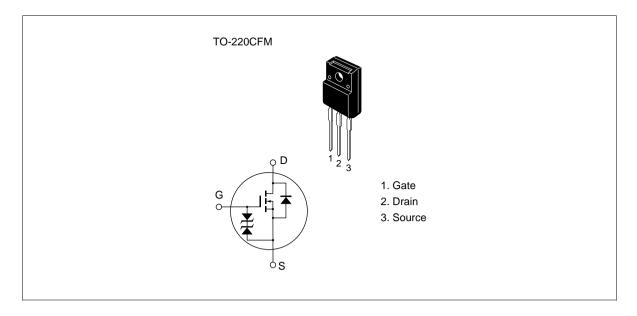
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for Switching regulator, DC-DC converter.

Outline





2SK2423

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	450	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	7	A
Drain peak current	I _{D(pulse)} *1	28	A
Body to drain diode reverse drain current	I _{DR}	7	A
Channel dissipation	Pch*2	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, duty cycle \leq 1 %

^{2.} Value at Tc = 25 °C

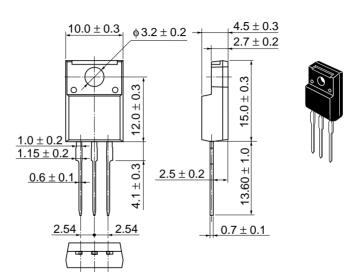
Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}		_	250	μΑ	V _{DS} =450 V, V _{GS} = 0
Gate to source cutoff voltage	$V_{\rm GS(off)}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	0.55	0.7	Ω	I _D = 4 A V _{GS} = 10 V* ¹
Forward transfer admittance	y _{fs}	4.5	7.0	_	S	$I_D = 4 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	1150	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	340	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	55	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	17	_	ns	I _D = 4 A
Rise time	t _r		55	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}		100	_	ns	$R_L = 7.5\Omega$
Fall time	t _f	_	45	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.9	_	V	$I_F = 7 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		330	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$

Note 1. Pulse Test

See characteristics curves of 2SK1159.

Unit: mm



Hitachi Code	TO-220CFM
JEDEC	_
EIAJ	_
Weight (reference value)	1.9 g

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